

Technical
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DFC220
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Fast Recovery Capsule Diode Type CXC220
860 amperes average: up to 1600 volts V_{RRM}

Ratings (Maximum values at T_j 125°C unless stated otherwise)

RATING	CONDITIONS	SYMBOL	
Average forward current	Half sine wave	$I_{F(AV)}$	55°C heatsink temperature (double side cooled) 860A
			100°C heatsink temperature (single side cooled) 212A
R.M.S. current (max.)	$T_{HS} = 25^\circ C$	$I_{F(RMS)}$	1745A
D.C. forward current (max.)	$T_{HS} = 25^\circ C$	I_F	1404A
Peak one-cycle surge non-repetitive	8.3ms sine pulse	$I_{FSM(1)}$	10460A
Maximum surge I^2t	8.3ms sine pulse	$I_{FSM(2)}$	11500A
		$I^2t(1)$	477000A ² s
Operating temperature range	3ms sine pulse	$I^2t(2)$	578000A ² s
		$I^2t(3)$	460000A ² s
Storage temperature range		T_{HS}	-40 + 125°C
		T_{stg}	-40 + 150°C

Characteristics (Maximum values at T_j 125°C unless stated otherwise)

CHARACTERISTIC	CONDITIONS	SYMBOL	
Peak forward volt drop	At 1200A I_{FM}	V_{FM}	1.55V
Forward conduction threshold voltage		V_0	1.17V
Forward conduction slope resistance		r	0.32mΩ
Peak reverse current	$V_{RM} = V_{RRM}$ (max.)	I_{RRM}	50mA
Thermal resistance junction to heatsink	Double side cooled	$R_{th(j-hs)}$	0.044°C/W
Reverse recovered charge	Single side cooled	$R_{th(j-hs)}$	0.088°C/W
	$I_{FM} = 800A, di/dt = 50 A/\mu s$ $V_{RM} = 50V$	Q_{rr}	140μC

VOLTAGE CODE	08	10	12	14	16	
Repetitive voltage V_{RRM}	800	1000	1200	1400	1600	
Non-repetitive voltage V_{RSM}	900	1100	1300	1500	1700	

Ordering Information (Please quote device code as explained below – 10 digits)

S	M	● ●	C X C	2 2 0
FIXED BASIC CODE	VOLTAGE CODE (see above)		FIXED OUTLINE CODE	FIXED TYPE CODE

Typical code: SM12CXC220 = 1200V_{RRM} capsule diode

1. INTRODUCTION

The SM08-16CXC220 diode series comprises fast recovery cold-weld capsules with 32mm all diffused silicon slices. All these diodes have controlled reverse recovery characteristics with good 'S' factors.

2. NOTES ON THE RATINGS

(a) Square wave ratings

These ratings are given for leading edge linear rates of rise of forward current of 100 and 200A/ μ s.

(b) Energy per pulse characteristics

These curves, when used in conjunction with those for the appropriate junction temperature rise, enable maximum operating frequencies and dissipations to be obtained.

(c) Junction temperature rise per pulse

Single pulse junction temperature rises are given for all rating conditions.

Let: E_p be the Energy per pulse for a given current and pulse width, in Joules

T be the appropriate junction temperature rise, in degrees Centigrade

R_{θ} be the steady-state thermal resistance (junction to sink)

and T_{SINK} be the heat sink temperature

the operating frequency may be obtained from

$$f = \frac{125 - T - T_{SINK}}{E_p R_{\theta}}$$

and the dissipation will be

$$W_{AV} = E_p f$$

3. REVERSE RECOVERY LOSS

On account of the number of circuit variables affecting reverse recovery voltage, no allowance for reverse recovery loss has been made in the forward ratings. The following procedure is suggested when it is necessary to include reverse recovery loss.

(a) Determination by Measurement

From waveforms of recovery current obtained from a high frequency shunt (see Note 1) and reverse voltage present during recovery, an instantaneous reverse recovery loss waveform must be constructed. Let the area under this waveform be A microjoules per pulse. An additional junction temperature rise per pulse can then be evaluated from:

$$\text{Total } T_J \text{ rise per pulse} = \text{Forward } T_J \text{ rise per pulse} + \frac{A r_t}{t}$$

$$\text{where } r_t = 8.1 \times 10^{-5} \sqrt{t}$$

where t = duration of reverse recovery loss per pulse in microseconds

where A = Area under reverse loss waveform per pulse in microjoules

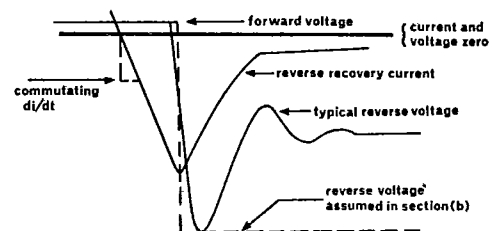
The Energy per pulse must also be modified to include the reverse recovery loss by adding

$$A \times 10^{-6} \text{ Joules}$$

to the forward energy per pulse values.

(b) Determination without measurement

Junction temperature rise per pulse per volt and Reverse Recovery Energy per pulse per volt curves are given for cases where it is not possible to measure the voltage and current conditions during reverse recovery. The Figure below shows the idealised situation during reverse recovery. In practice the reverse voltage has an initial overshoot (by an amount inversely proportional to the 'S' Factor) and then settles to a steady state during the recovery 'tail'. This method assumes that full voltage is present throughout the recovery.



The values obtained from these curves must be multiplied by the reverse voltage.

4. NOTE 1

REVERSE RECOVERY LOSS BY MEASUREMENT

When measuring the reverse recovered charge care must be taken to ensure that:

- (a) a.c. coupled devices such as current transformers are avoided, as they tend to exaggerate the apparent charge (due to the prior passage of forward current).
- (b) The measuring oscilloscope has adequate dynamic range – typically 100 screen heights – to cope with the initial forward current without overload.

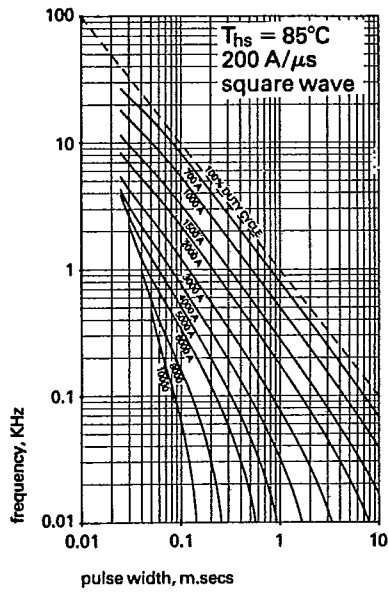


Figure 1 Frequency v. pulse width

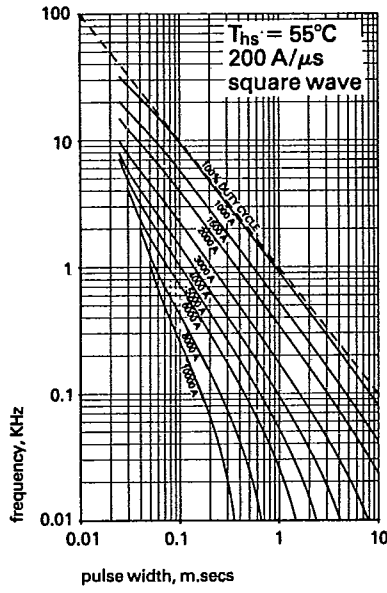


Figure 2 Frequency v. pulse width

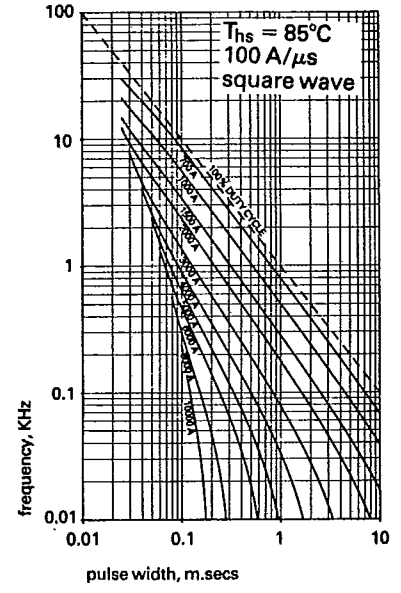


Figure 5 Frequency v. pulse width

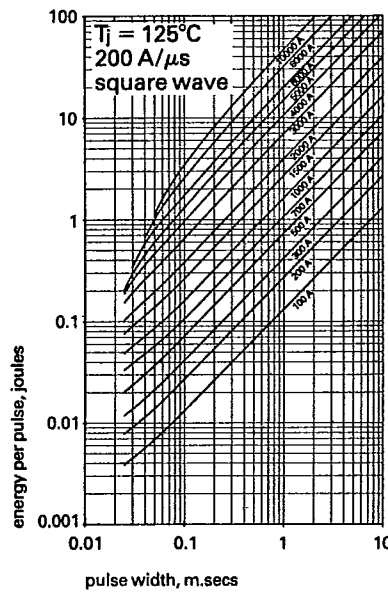


Figure 3 Energy per pulse v. pulse width

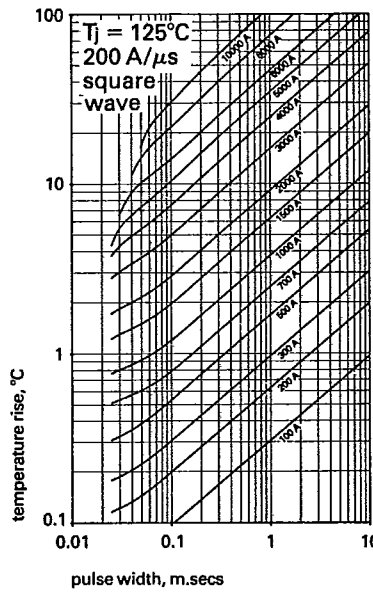


Figure 4 Temperature rise per pulse v. pulse width

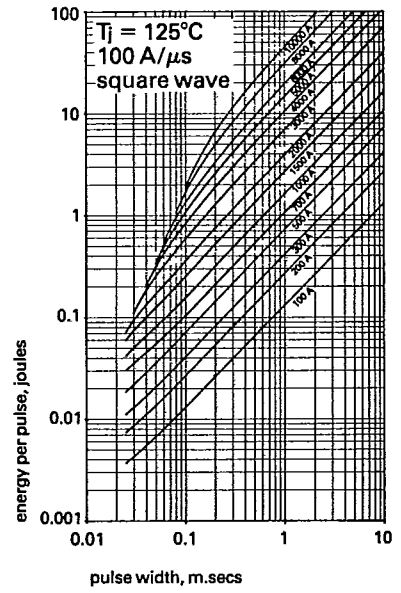


Figure 7 Energy per pulse v. pulse width

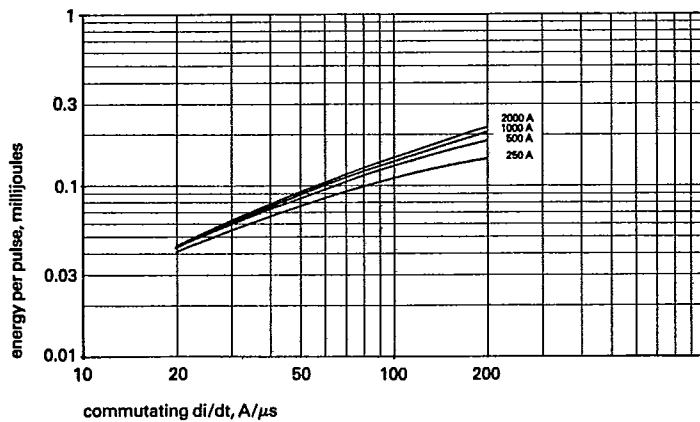


Figure 13 Max. reverse energy loss per pulse per recovery volt at T_j 125°C

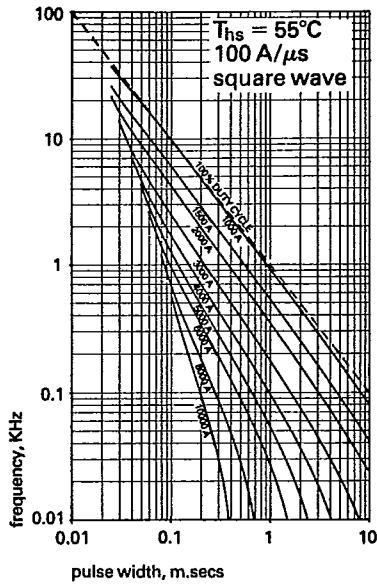


Figure 6 Frequency v. pulse width

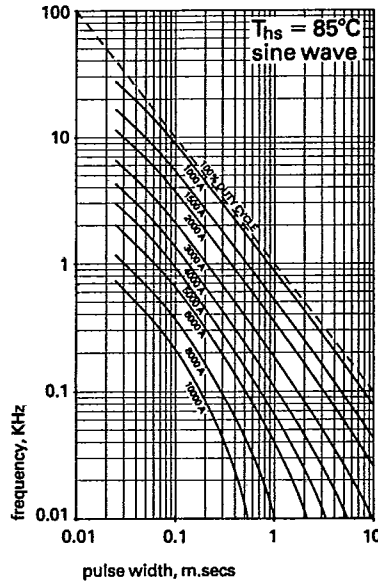


Figure 9 Frequency v. pulse width

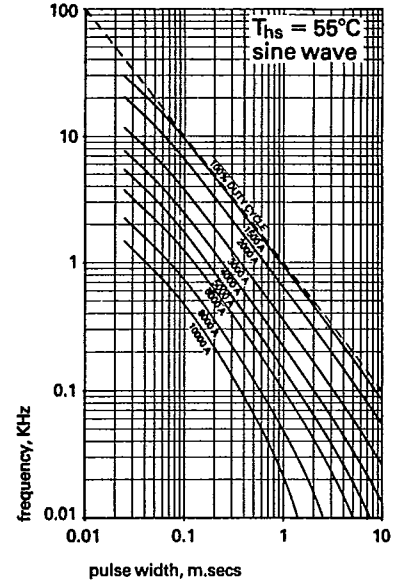


Figure 10 Frequency v. pulse width

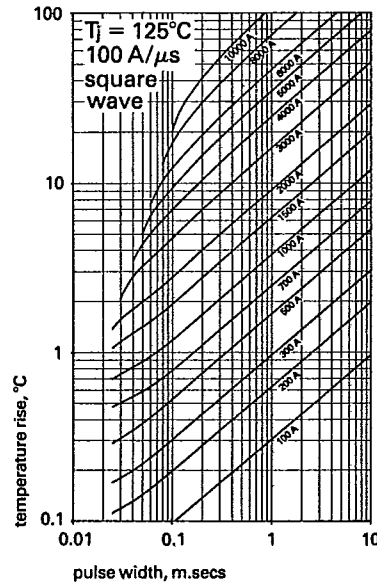


Figure 8 Temperature rise per pulse v. pulse width

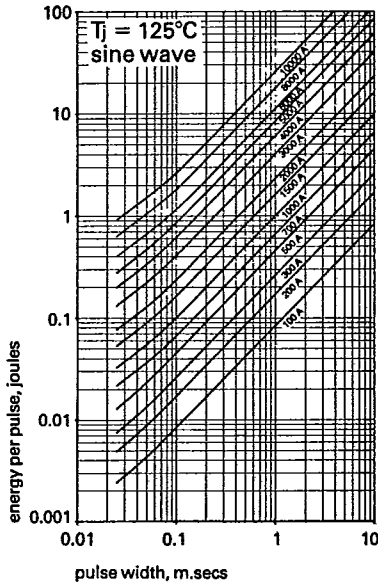


Figure 11 Energy per pulse v. pulse width

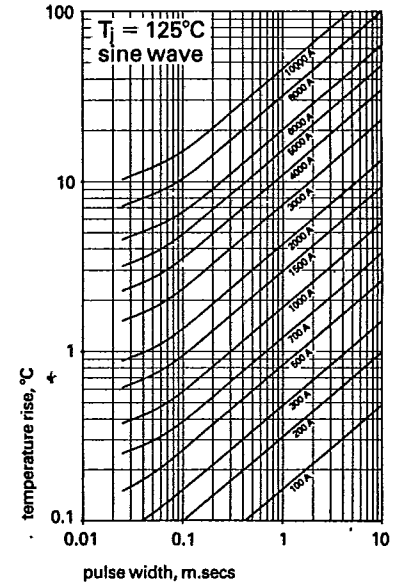


Figure 12 Temperature rise per pulse v. pulse width

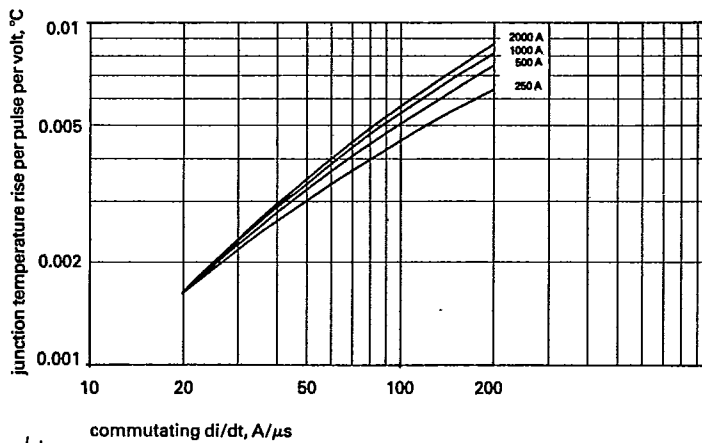


Figure 14 Max. junction temperature rise per pulse per recovery volt at T_j 125°C

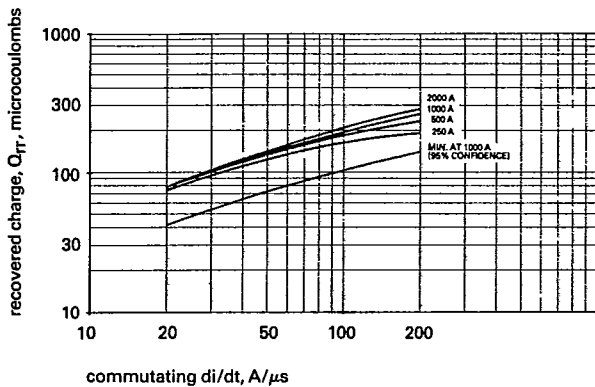


Figure 15 Maximum recovered charge at T_j 125°C

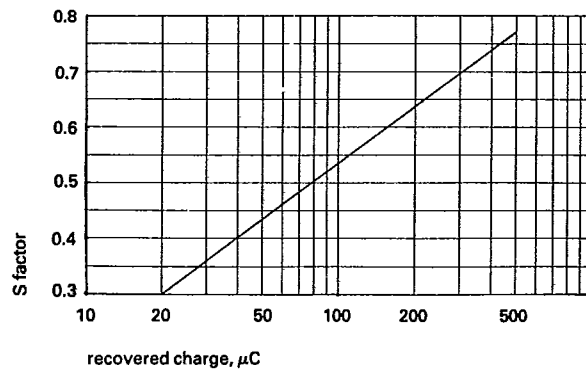


Figure 16 Minimum S factor at T_j 125°C

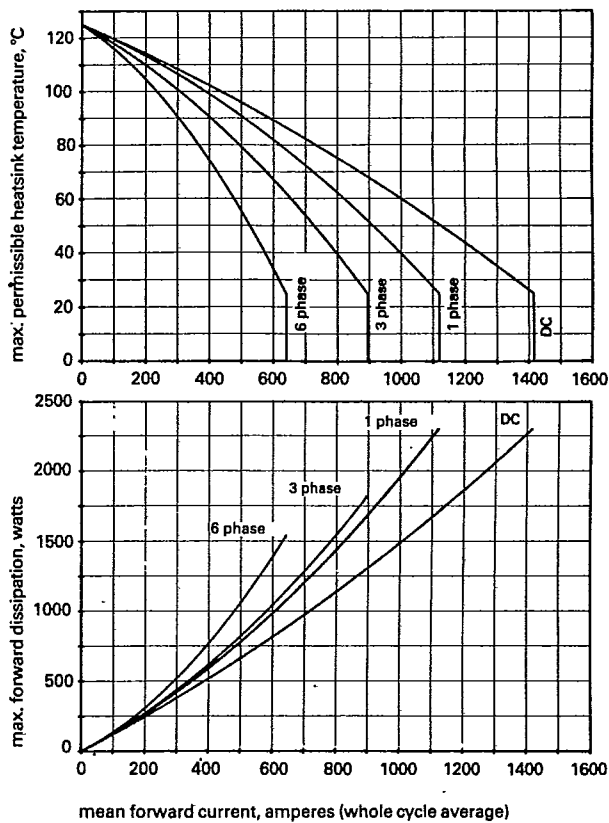


Figure 17 Dissipation and heatsink temperature v. current (double side cooled), 50Hz

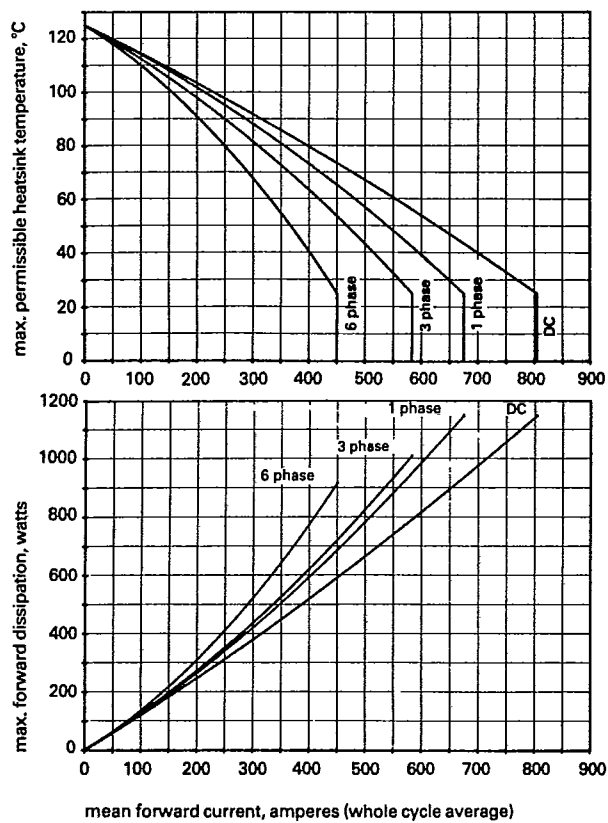


Figure 18 Dissipation and heatsink temperature v. current (single side cooled), 50Hz

34 DE 9709955 0001717 5

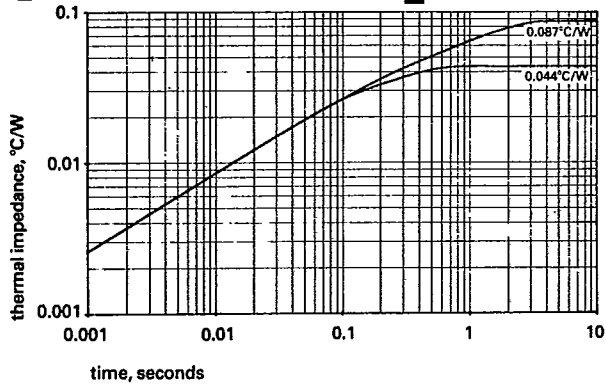


Figure 19 Junction to heatsink transient thermal impedance

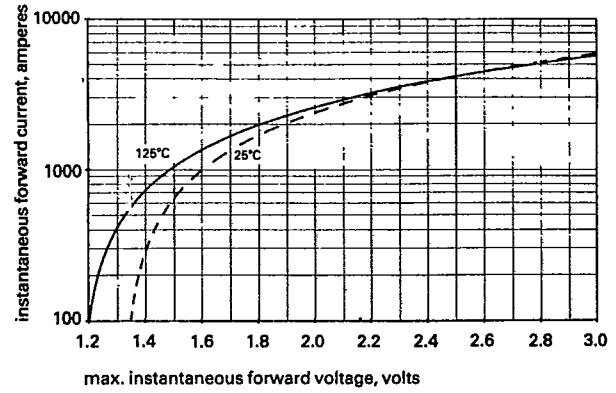


Figure 20 Forward voltage characteristic of limit diode

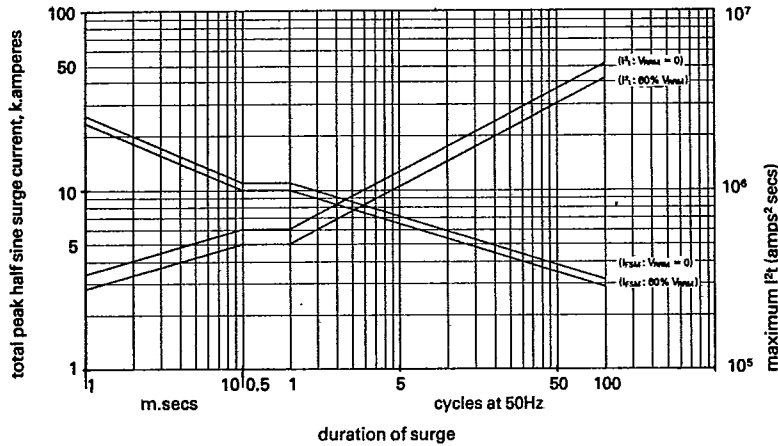
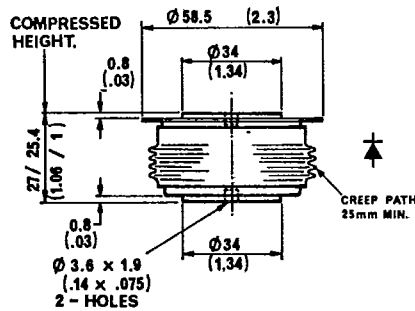


Figure 21 Max. non-repetitive surge current at initial junction temperature 125°C



DO - 200AB

dimensions in mm (inches)
mounting force: 1000-2000Kgf
weight: 340 grams

In the interest of product improvement, Westcode reserves the right to change specifications at any time without notice.

WESTCODE SEMICONDUCTORS

0-02 Fair Lawn Avenue, Fair Lawn, New Jersey 07410
Telephone (201) 791-3020 • Telex 130389

HAWKER SIDDELEY

Westinghouse Brake and Signal Co. Ltd.

6

